UNISONIC TECHNOLOGIES CO., LTD

3NM70 **Preliminary** Power MOSFET

3.0A, 700V N-CHANNEL SUPER-JUNCTION MOSFET

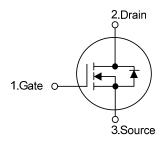
DESCRIPTION

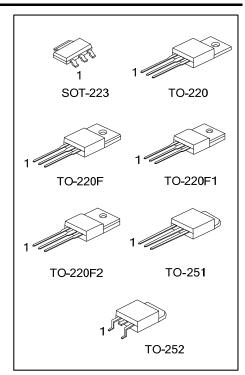
The UTC 3NM70 is an Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

FEATURES

- * $R_{DS(ON)}$ < 2.28 Ω @ V_{GS} = 10 V, I_{D} = 1.5 A
- * Low reverse transfer capacitance
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness



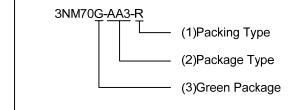




ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Dooking	
Lead Free	Halogen Free	Fackage	1	2	3	Packing	
-	3NM70G-AA3-T	SOT-223	G	D	S	Tube	
3NM70L-TA3-T	3NM70G-TA3-T	TO-220	G	D	S	Tube	
3NM70L-TF1-T	3NM70G-TF1-T	TO-220F1	G	D	S	Tube	
3NM70L-TF2-T	3NM70G-TF2-T	TO-220F2	G	D	S	Tube	
3NM70L-TF3-T	3NM70G-TF3-T	TO-220F	G	D	S	Tube	
3NM70L-TM3-T	3NM70G-TM3-T	TO-251	G	D	S	Tube	
3NM70L-TN3-R	3NM70G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



- (1) T: Tube, R: Tape Reel
- (2) AA3: SOT-223, TA3: TO-220, TF3: TO-220F,

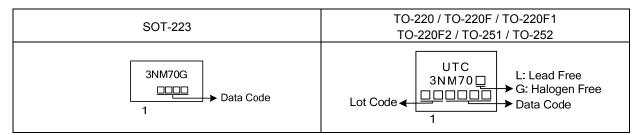
TF1: TO-220F1, TF2: TO-220F2, TM3: TO-251,

TN3: TO-252

(3) L: Lead Free, G: Halogen Free and Lead Free

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■ MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	700	V
Gate-Source Voltage		V_{GSS}	±30	V
Continuous Drain Current		I _D	3.0	Α
Pulsed Drain Current (Note 2)		I _{DM}	12	Α
Avalanche Current (Note 2)		I _{AR}	1.6	Α
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	13	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	5.0	V/ns
Power Dissipation	SOT-223		10	W
	TO-220		78	W
	TO-220F/TO-220F1	P_{D}	34	W
	TO-220F2		35	W
	TO-251/TO-252		50	W
Junction Temperature		T_J	+150	ç
Storage Temperature		T _{STG}	-55 ~ + 150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 10mH, I_{AS} = 1.6A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C
- 4. $I_{SD} \leq 3.0 A$, di/dt $\leq 200 A/\mu s$, $V_{DD} \leq BV_{DSS}$, Starting T_J = 25°C

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	SOT-223		150	°C/W
	TO-220/TO-220F TO-220F1/TO-220F2	θЈА	62.5	°C/W
	TO-251/TO-252		110	°C/W
Junction to Case	SOT-223		12.5	°C/W
	TO-220		1.6	°C/W
	TO-220F/TO-220F1	θ_{JC}	3.68	°C/W
	TO-220F2		3.58	°C/W
	TO-251/TO-252		2.5	°C/W

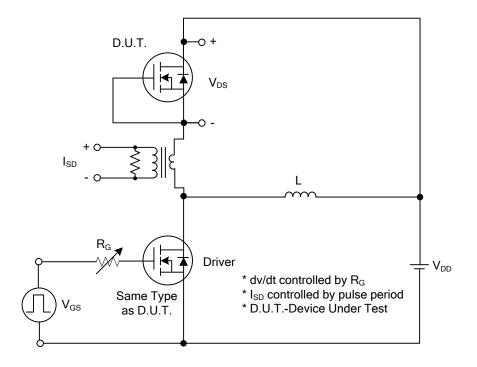
■ ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	700			V	
Drain-Source Leakage Current		I _{DSS}	V _{DS} = 700 V, V _{GS} = 0 V			10	μA	
Gate-Source Leakage Current	Forward	I _{GSS}	V _{GS} = 30 V, V _{DS} = 0 V			100	nA	
	Reverse		V _{GS} = -30 V, V _{DS} = 0 V			-100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.5	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	$V_{GS} = 10 \text{ V}, I_D = 1.5 \text{A}$			2.28	Ω	
DYNAMIC CHARACTERISTICS					-	ā,		
Input Capacitance	put Capacitance		V _{GS} =0V, V _{DS} =25V, f =1MHz		146		pF	
Output Capacitance		C _{ISS}			131		pF	
Reverse Transfer Capacitance		C _{RSS}			16		pF	
SWITCHING CHARACTERISTICS								
Total Gate Charge (Note 1)		Q_{G}	V _{DS} =50V, V _{GS} =10V, I _D =1.3A,		37		nC	
Gate to Source Charge		Q_GS	$I_D=100\mu A$ (Note 1, 2)		5.2		nC	
Gate to Drain Charge		Q_GD	1D-100μΑ (Note 1, 2)		6.4		nC	
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$			32		ns	
Rise Time		t_R	V_{DS} =30V, V_{GS} =10V, I_{D} =0.5A,		59		ns	
Turn-OFF Delay Time		$t_{D(OFF)}$	R _G =25Ω (Note 1, 2)		104		ns	
Fall-Time		t_{F}			36		ns	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Body-Diode Continuous	Current	Is				3.0	Α	
Maximum Body-Diode Pulsed Current		I _{SM}				12	Α	
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =3.0A, V _{GS} =0V			1.4	V	
Body Diode Reverse Recovery Time (Note 1)		t _{rr}	I _S =3.0A, V _{GS} =0V,		258		ns	
Body Diode Reverse Recovery Charge		Q_{rr}	dI _F /dt=100A/μs		1.6		μC	

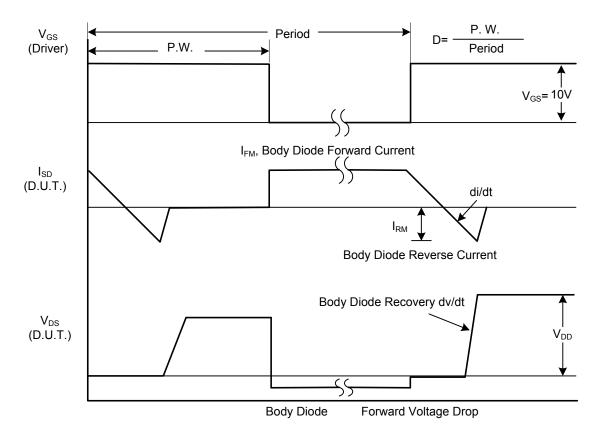
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle≤2%

^{2.} Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

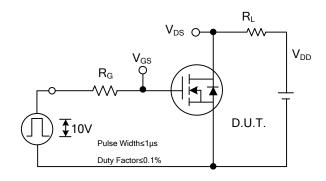


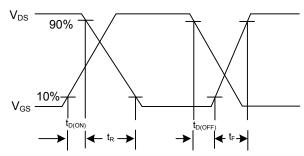
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

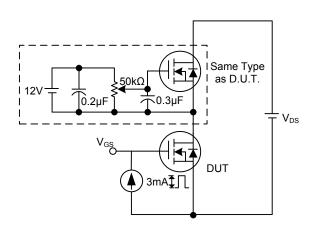
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

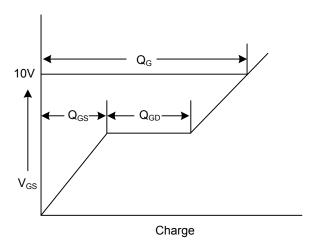




Switching Test Circuit

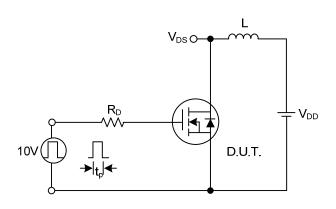
Switching Waveforms

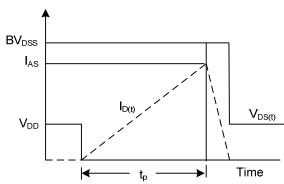




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

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